



1.0X0.5mm SMD CHIP LED LAMP

Features

- 1.0mmX0.5mm SMT LED, 0.5mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- \bullet VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

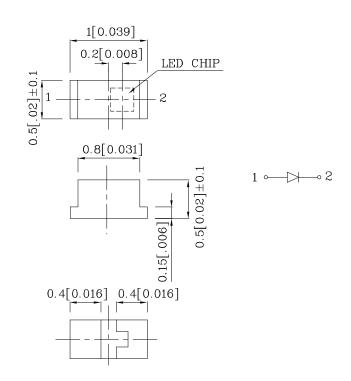




Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		MDK (InGaAlP)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	mA
Power Dissipation	Рт	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

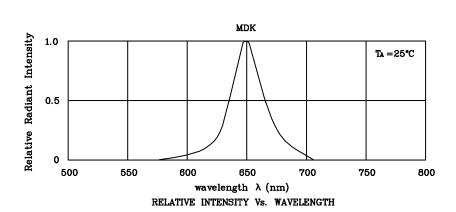


Operating Characteristics (TA=25°C)		MDK (InGaAlP)	Unit
Forward Voltage (Typ.) (IF=20mA)	V_{F}	1.95	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	650	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	635	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	28	nm
Capacitance (VF=0V, f=1MHz)	С	35	pF

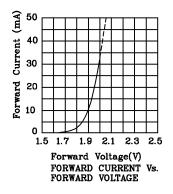
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
ZMDK68W-2	Red	InGaAlP	Water Clear	50	148	650	120°
Published Date : FI	EB 23, 2008	Drawing No	: SDSA4422	V4	Check	ed : B.L.LIU	P.1/4

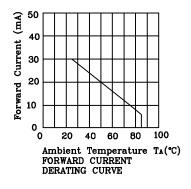


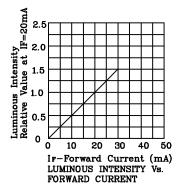
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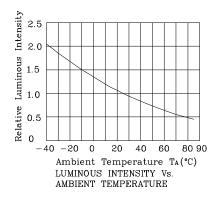


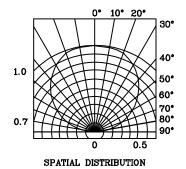
❖ MDK









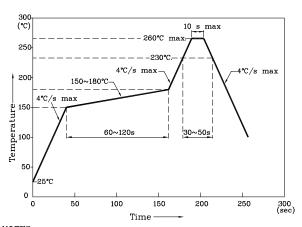






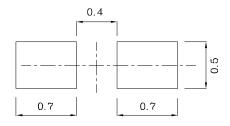
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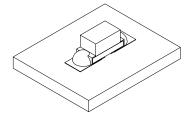
Reflow Soldering Profile For Lead-free SMT Process.



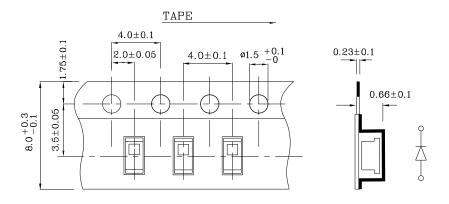
NOTES:

- 1. Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- ❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- **❖** The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

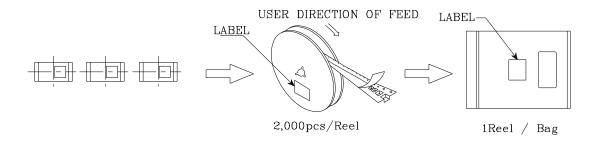
Note: Accuracy may depend on the sorting parameters.

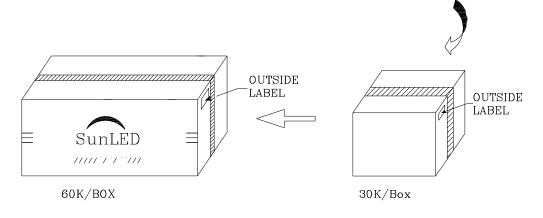


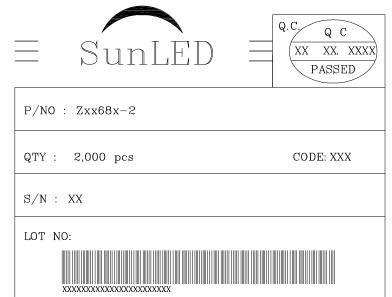
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PACKING & LABEL SPECIFICATIONS

ZMDK68W-2







Published Date : FEB 23, 2008 Drawing No : SDSA4422 V4 Checked : B.L.LIU P.4/4

RoHS Compliant